



NOTES:
 1. MATERIAL:
 HOUSING: LCP, BLACK, UL 94V-0
 CONTACT: PHOSPHORBRONZE, T=0.15MM
 SHELL: STAINLESS STEEL T=0.20MM
 2. FINISH:
 CONTACT: 50U'' MIN PLATING OVER ALL
 GOLD FLASH ON THE CONTACT AREA & SOLDER AREA
 SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA
 50U'' NI MIN. PLATING OVER ALL
 3. ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
 4. ALL DIMENSIONS MARKER (XX) MUST BE MEASURED BY FAI.

T-CARD PIN NO.	PIN NO.
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DATO
T8	DAT1
SIM CARD PIN NO.	PIN NO.
P1-A/B	VCC
P2-A/B	RST
P3-A/B	CLK
P5-A/B	GND
P6-A/B	VPP
P7-A/B	I/O

RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
C	E1703049A	调整弹片高度	03/10/2017	DATE: 10/27/2014	X. ±0.25 .X ±0.15 .XX ±0.10 .XXX ±0.05	X° ±2.00° .X° ±1.00° .XX° ±0.50°	S37-0B20F25F
B	E1512489A	主体铁壳变更	12/13/2015	SCALE: 5:1		CHECKED:	TITLE: MICRO SIM CARD+SIM CARD+ T-CARD H=2.55mm
A	---	NEW	10/27/2014	SHEET: 1/1	MATERIAL:	APPROVE:	DRAWING NO:
				REV. A	FINISH: SEE NOTE		

 昆山捷皇电子精密科技有限公司
 HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.